ST2329

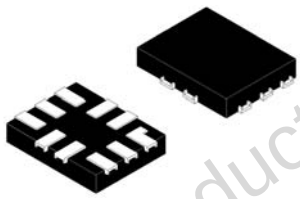
2-bit dual supply level translator without direction control pin

Features

- 90 Mbps (max) data rate when driven by a totem pole driver
- 8 Mbps (max) data rate when driven by an open drain pole driver
- Bidirectional level translation without direction control pin
- Wide V_L voltage range of 1.65 to 3.6 V
- Wide V_{CC} voltage range of 1.80 to 5.5 V
- Power down mode feature – when either supply is off, all I/Os are in high impedance
- Low quiescent current (max 12 µA)
- Able to be driven by totem pole and open drain drivers
- 5.5 V tolerant enable pin
- ESD performance on all pins: ±2 kV HBM
- Small package and footprint QFN10L (1.8 x 1.4 mm) package

Applications

- Low voltage system level translation
- Mobile phones and other mobile devices
- I^2C level translation
- UART level translation



QFN10L (1.8 x 1.4 mm)

Description

The ST2329 is a 2-bit dual supply level translator which provides the level shifting capability to allow data transfer in a multi-voltage system. Externally applied voltages, V_{CC} and V_L, set the logic levels on either side of the device. It utilizes transmission gate-based design that allows bidirectional level translation without a control pin.

The ST2329 accepts a V_L from 1.65 to 3.6 V and V_{CC} from 1.80 to 5.5 V, making it ideal for data transfer between low-voltage ASICs/PLD and higher voltage systems. This device has a tri-state output mode which can be used to disable all I/Os.

The ST2329 supports power down mode when V_{CC} is grounded/floating and the device is disabled via the OE pin.

Obsolete Product(s) - Obsolete Product(s)

Table 1. Device summary

Order code	Package	Packaging
ST2329QTR	QFN10L (1.8 x 1.4 mm)	Tape and reel (3000 parts per reel)

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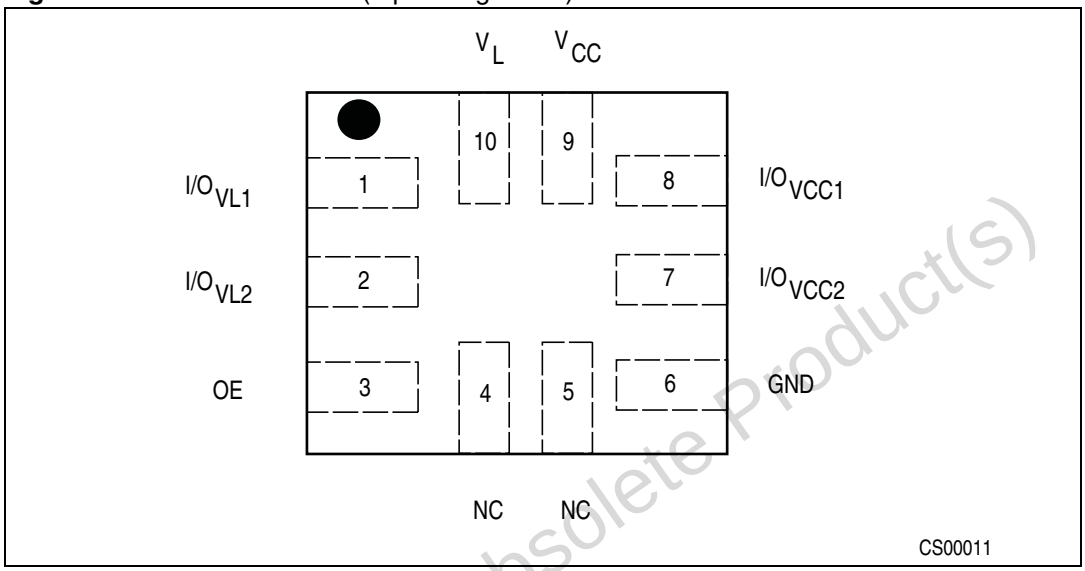
8 **Revision history** 20

Obsolete Product(s) - Obsolete Product(s)

1 Pin settings

1.1 Pin connection

Figure 1. Pin connection (top through view)



1.2 Pin description

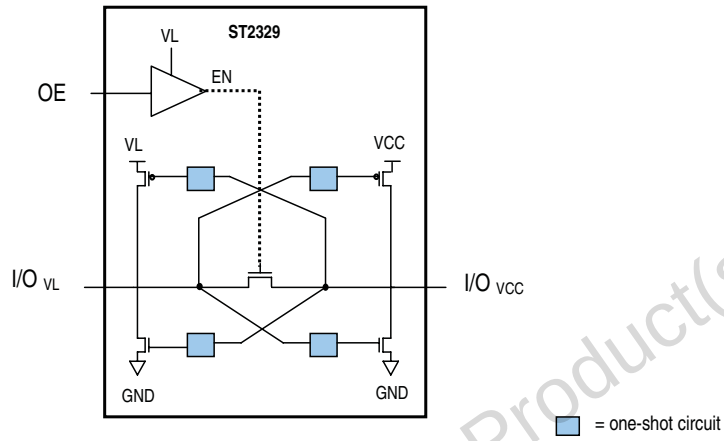
Table 2. Pin description

Pin number	Symbol	Name and function
1	I/O_{VL1}	Data input/output
2	I/O_{VL2}	Data input/output
3	OE	Output enable
4	NC	No connection
5	NC	No connection
6	GND	Ground
7	I/O_{VCC2}	Data input/output
8	I/O_{VCC1}	Data input/output
9	V_{CC}	Supply voltage
10	V_L	Supply voltage

Obsolete Product(s) - Obsolete Product(s)

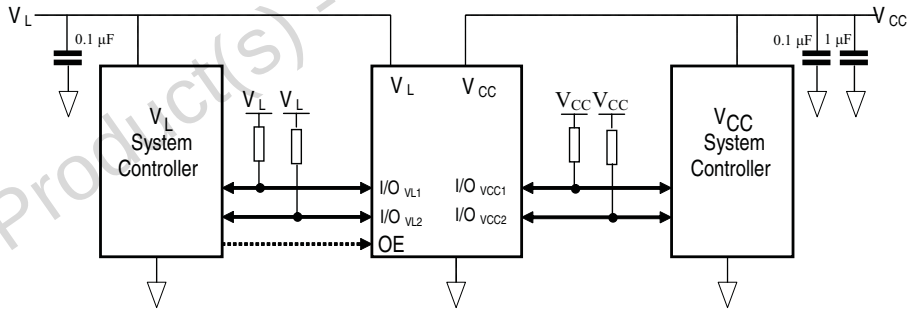
2 Device block diagrams

Figure 2. ST2329 block diagram



* ST2329 has 2 channels. For simplicity, the above diagram shows only 1 channel.
* When OE is Low, all I/Os are in High-Impedance mode.

Figure 3. Application block diagram



Obsolete Product(s) - Obsolete Product(s)

3 Supplementary notes

3.1 Driver requirement

The ST2329 may be driven by an open drain or totem pole driver and the nature of the device's output is "open drain". It must not be used to drive a pull-down resistor since the impedance of the output at HIGH state depends on the pull-up resistor placed at the I/Os.

As the device has pull-up resistors on both the I/O_{VCC} and I/O_{VL} ports, the user needs to ensure that the driver is able to sink the required amount of current. For example, if the settings are V_{CC} = 5.5 V, V_L = 4.3 V and the pull-up resistor is 10 kΩ, then the driver must be able to sink at least (5.5 V/10 kΩ) + (4.3 V /10 kΩ) = 1 mA and still meet the V_{IL} requirements of the ST2329.

3.2 Load driving capability

To support the open drain system, the one-shot transistor is turned on only during state transition at the output side. When it drives a high state, after the one-shot transistor is turned off, only the pull-up resistor is able to maintain the state. In this case, the resistive load is not recommended.

During the translation from V_{CC} side to V_L side, the oscillation might be triggered when the signal is reflected back as a glitch. This is caused by the architecture of the device (auto-direction).

When using the ST2329, care need to be taken in the PCB data-track design and output loading. It is recommended that the load is less than 25 pf.

3.3 Power off feature

In some applications where it might be required to turn off one of the power supplies powering up the level translator, the user may turn off the V_{CC} only when the OE pin is low (device is disabled). There will be no current consumption in V_L due to floating gates or other causes, and the I/Os are in a high-impedance state in this mode.

3.4 Truth table

Table 3. Truth table

Enable	Bidirectional Input/Output	
OE	**I/O_{VCC}**	**I/O_{VL}**
H (1)	H (2)	H(1)
H(1)	L	L
L	Z (3)	Z(3)

1. High level V_L power supply referred
2. High level V_{CC} power supply referred
3. Z = high impedance

Obsolete Product(s) - Obsolete Product(s)

4 Maximum rating

Stressing the device above the rating listed in the “Absolute maximum ratings” table may cause permanent damage to the device. These are stress ratings only, and operation of the device at these or any other conditions above those indicated in the operating sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

Table 4. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_L	Supply voltage	-0.3 to 4.6	V
V_{CC}	Supply voltage	-0.3 to 6.5	V
V_{OE}	DC control input voltage	-0.3 to 6.5	V
$V_{I/OVL}$	DC I/O_{VL} input voltage (OE = GND or V_L)	-0.3 to V_L + 0.3	V
$V_{I/OVCC}$	DC I/O_{VCC} input voltage (OE = GND or V_L)	-0.3 to V_{CC} + 0.3	V
I_{IK}	DC input diode current	-20	mA
$I_{I/OVL}$	DC output current	±25	mA
$I_{I/OVCC}$	DC output current	±258	mA
I_{SCTOUT}	Short circuit duration, continuous	40	mA
P_D	Power dissipation(1)	500	mW
T_{STG}	Storage temperature	-65 to 150	°C
TL	Lead temperature (10 seconds)	300	°C
ESD	Electrostatic discharge protection (HBM)	±2	kV

1. 500mW: 65 °C derated to 300 mW by 10W/°C: 65 °C to 85 °C

4.1 Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Min	Typ	Max	Unit
V_L	Supply voltage	1.65		3.6	V
V_{CC}(1)	Supply voltage	1.8		5.5	V
V_{OE}	Input voltage (OE output enable pin, V_L power supply referred)	0		3.6	V
VI/O_{VL}	I/O_{VL} voltage	0		V_L	V
V_I/O_{VCC}	I/O_{VCC} voltage	0		V_{CC}	V
T_{op}	Operating temperature	-40		85	°C
dt/dV	Input rise and fall time (for 45 Mbps operation)	0		1	ns/V

1. V_{CC} must be greater than V_L.

Obsolete Product(s) - Obsolete Product(s)

5 Electrical characteristics

Table 6. **DC characteristics** (over recommended operating conditions unless otherwise noted. All typical values are at T_A = 25 °C)

Symbol	Parameter	Test conditions			Value					Unit
		V_L	V_{CC}		TA = 25 °C			-40 to 85 °C		
					Min	Typ	Max	Min	Max	
V_{IHL}	High level input voltage (I/O_{VL})	1.65	V_L to 5.5		1.4			1.4		V
		2.0			1.6			1.6		
		2.5			2.0			2.0		
		3.0			2.4			2.4		
		3.6			2.8			2.8		
V_{ILL}	Low level input voltage (I/O_{VL})	1.65	V_L to 5.5				0.3		0.3	V
		2.0					0.4		0.4	
		2.5					0.5		0.5	
		3.0					0.6		0.6	
		3.6					0.8		0.8	
V_{IHC}	High level input voltage (I/O_{VCC})	1.65 to V_{CC}	1.8		1.6			1.6		V
			2.5		2.3			2.3		
			3.0		2.7			2.7		
			3.6		3.3			3.3		
			4.3		3.5			3.5		
			5.5		4.2			4.2		
V_{ILC}	Low level input voltage (I/O_{VCC})	1.65 - 2.5	3 - 5.5					0.3		V
		2.7 - 3.6	3.6 - 5.5					0.5		
V_{IH-OE}	High level input voltage (OE)	1.65	V_L to 5.5		1.0			1.0		V
		2.0			1.2			1.2		
		2.5			1.4			1.4		
		3.0			1.6			1.6		
		3.6			2.0			2.0		
V_{IL-OE}	Low level input voltage (OE)	1.65	V_L to 5.5				0.33		0.33	V
		2.0					0.40		0.40	
		2.5					0.50		0.50	
		3.0					0.60		0.60	
		3.6					0.75		0.75	

Obsolete Product(s) - Obsolete Product(s)

Table 6. DC characteristics (over recommended operating conditions unless otherwise noted. All typical values are at T_A = 25 °C) (continued)

Symbol	Parameter	Test conditions			Value					Unit
		V_L	V_{CC}		TA = 25 °C			-40 to 85 °C		
					Min	Typ	Max	Min	Max	
V_{OLL}	Low level output voltage (I/O_{VL})	1.65 to 3.6	V_L to 5.5	IO = 1.0 mA $I/O_{VCC} \leq 0.15$ V			0.40		0.40	V
V_{OLC}	Low level output voltage (I/O_{VCC})	1.65 to 3.6	V_L to 5.5	IO = 1.0 mA $I/O_{VL} \leq 0.15$ V			0.40		0.40	V
I_{OE}	Control input leakage current (OE)	1.65 to 3.6	V_L to 5.5	V_{OE} = GND or V_L			±0.1		±0.1	µA
I_{IO_LKG}	High impedance leakage current (I/O_{VL}, I/O_{VCC})	1.65 to 3.6	V_L to 5.5	OE = GND			±0.1		±0.1	µA
I_{QVCC}	Quiescent supply current V_{CC}	1.65 to 3.6	V_L to 5.5	only pull-up resistor connected to I/O		3	5		12	µA
I_{QVL}	Quiescent supply current V_L	1.65 to 3.6	V_L to 5.5	only pull-up resistor connected to I/O		0.01	0.1		1	µA
$I_{Z\text{-}VCC}$	High impedance quiescent supply current V_{CC}	1.65 to 3.6	V_L to 5.5	OE = GND; only pull-up resistor connected to I/O		3	5		12	µA
$I_{Z\text{-}VL}$	High impedance quiescent supply current V_L	1.65 to 3.6	V_L to 5.5	OE = GND; only pull-up resistor connected to I/O		0.01	0.1		1	µA

Obsolete Product(s) - Obsolete Product(s)

5.1 AC characteristics (device driven by open drain driver)

Table 7. **AC characteristics** - test conditions: V_L = 1.65 –1.8 V (load C_L = 15 pF; R_{up} = 4.7 kΩ; driver $t_r = t_f \leq 2$ ns) over temperature range -40 °C to 85 °C

Symbol	Parameter		V_{CC} = 1.8 –2.5 V		V_{CC} = 2.7 –3.6 V		V_{CC} = 4.3 – 5.5 V		Unit
			Min	Max	Min	Max	Min	Max	
t_{RVCC}	Rise time I/O_{VCC}			80		50		30	ns
t_{FVCC}	Fall time I/O_{VCC}			3		3		3	ns
t_{RVL}	Rise time I/O_{VL}			7		6		6	ns
t_{FVL}	Fall time I/O_{VL}			4		5		5	ns
$t_{I/OVL-VCC}$	Propagation delay time I/O_{VL-LH} to I/O_{VCC-LH} I/O_{VL-HL} to I/O_{VCC-HL}	t_{PLH}		5		5		5	ns
		t_{PHL}		5		5		5	ns
$t_{I/OVCC-VL}$	Propagation delay time I/O_{VCC-LH} to I/O_{VL-LH} I/O_{VCC-HL} to I/O_{VL-LH}	t_{PLH}		5		5		5	ns
		t_{PHL}		5		7		7	ns
t_{PZL} t_{PZH} t_{PLZ} t_{PHZ}	Output enable and disable time	En		10		10		10	ns
		Dis		40		40		40	ns
D_R	Data rate(1)			1.6		2.5		4	MHz

1. The data rate is guaranteed based on the condition that the output I/O signal rise/fall time is less than 15% of the input I/O signal period; the input I/O signal is at 50% duty cycle and the output I/O signal duty cycle deviation not less than 30%.

Table 8. **AC characteristics** - test conditions: V_L = 2.5 –2.7 V (load C_L = 15 pF; R_{up} = 4.7 kΩ; driver $t_r = t_f \leq 2$ ns) over temperature range -40 °C to 85 °C

Symbol	Parameter		V_{CC} = 2.7 –3.6 V		V_{CC} = 4.3 – 5.5 V		Unit
			Min	Max	Min	Max	
t_{RVCC}	Rise time I/O_{VCC}			70		40	ns
t_{FVCC}	Fall time I/O_{VCC}			3		3	ns
t_{RVL}	Rise time I/O_{VL}			5		5	ns
t_{FVL}	Fall time I/O_{VL}			3		3	ns
$t_{I/OVL-VCC}$	Propagation delay time I/O_{VL-LH} to I/O_{VCC-LH} I/O_{VL-HL} to I/O_{VCC-HL}	t_{PLH}		2		2	ns
		t_{PHL}		3		3	ns
$t_{I/OVCC-VL}$	Propagation delay time I/O_{VCC-LH} to I/O_{VL-LH} I/O_{VCC-HL} to I/O_{VL-LH}	t_{PLH}		3		3	ns
		t_{PHL}		4		4	ns

Obsolete Product(s) Obsolete Product(s)

Table 8. AC characteristics - test conditions: V_L = 2.5 –2.7 V (load C_L = 15 pF; R_{up} = 4.7 kΩ; driver $t_r = t_f \leq 2$ ns) over temperature range -40 °C to 85 °C

Symbol	Parameter		V_{CC} = 2.7 –3.6 V		V_{CC} = 4.3 – 5.5 V		Unit
			Min	Max	Min	Max	
t_{PZL} t_{PZH} t_{PLZ} t_{PHZ}	Output enable and disable time	En		6		6	ns
		Dis		40		40	ns
D_R	Data rate(1)			2.5		3.2	MHz

1. The data rate is guaranteed based on the condition that the output I/O signal rise/fall time is less than 15% of the input I/O signal period; the input I/O signal is at 50% duty cycle and the output I/O signal duty cycle deviation not less than 30%.

Table 9. AC characteristics - test conditions: V_L = 2.7 –3.6 V (load C_L = 15 pF; R_{up} = 4.7 kΩ; driver $t_r = t_f \leq 2$ ns) over temperature range -40 °C to 85 °C

Symbol	Parameter		V_{CC} = 4.3 – 5.5 V		Unit
			Min	Max	
t_{RVCC}	Rise time I/O_{VCC}			55	ns
t_{FVCC}	Fall time I/O_{VCC}			3	ns
t_{RVL}	Rise time I/O_{VL}			4	ns
t_{FVL}	Fall time I/O_{VL}			3	ns
$t_{I/OVL-VCC}$	Propagation delay time I/O_{VL-LH} to I/O_{VCC-LH} I/O_{VL-HL} to I/O_{VCC-HL}	t_{PLH}		2	ns
		t_{PHL}		4	ns
$t_{I/OVCC-VL}$	Propagation delay time I/O_{VCC-LH} to I/O_{VL-LH} I/O_{VCC-HL} to I/O_{VL-HL}	t_{PLH}		4	ns
		t_{PHL}		4	ns
t_{PZL} t_{PZH} t_{PLZ} t_{PHZ}	Output enable and disable time	En		6	ns
		Dis		40	ns
D_R	Data rate(1)			2.8	MHz

1. The data rate is guaranteed based on the condition that the output I/O signal rise/fall time is less than 15% of the input I/O signal period; the input I/O signal is at 50% duty cycle and the output I/O signal duty cycle deviation not less than 30%.

Obsolete Product(s) - Obsolete Product(s)

5.2 AC characteristics (device driven by totem pole driver)

Table 10. AC characteristics (test conditions: V_L = 1.65 –1.8 V (load C_L = 15 pF; R_{up} = 10 kΩ; driver t_r=t_f ≤ 2 ns) over temperature range -40 °C to 85 °C)

Symbol	Parameter		V_{CCB} = 1.8 – 2.5 V		V_{CCB} = 2.7 – 3.6 V		V_{CCB} = 4.3 – 5.5 V		Unit
			Min	Max	Min	Max	Min	Max	
t_{RVCC}	Rise time I/O_{VCC}			7		3		4	ns
t_{FVCC}	Fall time I/O_{VCC}			7		3		3	ns
t_{RVL}	Rise time I/O_{VL}			6		4		5	ns
t_{FVL}	Fall time I/O_{VL}			4		4		4	ns
$t_{I/OVL-VCC}$	Propagation delay time I/O_{VL-LH} to I/O_{VCC-LH} I/O_{VL-HL} to I/O_{VCC-HL}	t_{PLH}		6		5		4	ns
		t_{PHL}		5		5		5	ns
$t_{I/OVCC-VL}$	Propagation delay time I/O_{VCC-LH} to I/O_{VL-LH} I/O_{VCC-HL} to I/O_{VL-HL}	t_{PLH}		6		5		4	ns
		t_{PHL}		4.5		5.2		7	ns
t_{PZL} t_{PZH} t_{PLZ} t_{PHZ}	Output enable and disable time	En		10		10		10	ns
		Dis		40		40		40	ns
D_R	Data rate(1)			12		32		32	MHz

1. The data rate is guaranteed based on the condition that the output I/O signal rise/fall time is less than 15% of the input I/O signal period; the input I/O signal is at 50% duty cycle and the output I/O signal duty cycle deviation not less than 30%.

Table 11. AC characteristics (test conditions: V_L = 2.5 –2.7 V (load C_L = 15 pF; R_{up} = 10 kΩ; driver t_r = t_f ≤2 ns) over temperature range -40 °C to 85 °C)

Symbol	Parameter		V_{CC} = 2.7 –3.6 V		V_{CC} = 4.3 –5.5 V		Unit
			Min	Max	Min	Max	
t_{RVCC}	Rise time I/O_{VCC}			6		4	ns
t_{FVCC}	Fall time I/O_{VCC}			3		3	ns
t_{RVL}	Rise time I/O_{VL}			5		5	ns
t_{FVL}	Fall time I/O_{VL}			3		3	ns
$t_{I/OVL-VCC}$	Propagation delay time I/O_{VCC-LH} to I/O_{VL-LH} I/O_{VCC-HL} to I/O_{VL-HL}	t_{PLH}		3.5		3	
		t_{PHL}		4		4	ns
$t_{I/OVCC-VL}$	Propagation delay time I/O_{VCC-LH} to I/O_{VL-LH} I/O_{VCC-HL} to I/O_{VL-HL}	t_{PLH}		2.5		2.1	ns
							ns
		t_{PHL}		4		4	ns
							ns

Obsolete Product(s) - Obsolete Product(s)

Table 11. AC characteristics (test conditions: V_L = 2.5 –2.7 V (load C_L = 15 pF; R_{up} = 10 kΩ; driver $t_r = t_f \leq 2$ ns) over temperature range -40 °C to 85 °C) (continued)

Symbol	Parameter		V_{CC} = 2.7 –3.6 V		V_{CC} = 4.3 –5.5 V		Unit
			Min	Max	Min	Max	
t_{PZL} t_{PZH} t_{PLZ} t_{PHZ}	Output enable and disable time	En		6		6	ns
		Dis		40		40	ns
D_R	Data rate(1)			45		45	MHz

1. The data rate is guaranteed based on the condition that the output I/O signal rise/fall time is less than 15% of the input I/O signal period; the input I/O signal is at 50% duty cycle and the output I/O signal duty cycle deviation not less than 30%.

Table 12. AC characteristics (test conditions: V_L = 2.7 –3.6 V (load C_L = 15 pF; R_{up} = 10 kΩ; driver $t_r = t_f \leq 2$ ns) over temperature range -40 °C to 85 °C)

Symbol	Parameter		V_{CC} = 4.3 –5.5 V		Unit
			Min	Max	
t_{RVCC}	Rise time I/O_{VCC}			5	ns
t_{FVCC}	Fall time I/O_{VCC}			3	ns
t_{RVL}	Rise time I/O_{VL}			4	ns
t_{FVL}	Fall time I/O_{VL}			3	ns
$t_{I/OVL-VCC}$	Propagation delay time I/O_{VL-LH} to I/O_{VCC-LH} I/O_{VL-HL} to I/O_{VCC-HL}	t_{PLH}		2.5	ns
		t_{PHL}		4	ns
$t_{I/OVCC-VL}$	Propagation delay time I/O_{VCC-LH} to I/O_{VL-LH} I/O_{VCC-HL} to I/O_{VL-HL}	t_{PLH}		2	ns
					ns
		t_{PHL}		4	ns
					ns
t_{PZL} t_{PZH} t_{PLZ} t_{PHZ}	Output enable and disable time	En		6	ns
		Dis		40	ns
D_R	Data rate(1)			45	MHz

1. The data rate is guaranteed based on the condition that the output I/O signal rise/fall time is less than 15% of the input I/O signal period; the input I/O signal is at 50% duty cycle and the output I/O signal duty cycle deviation not less than 30%.

Obsolete Product(s) - Obsolete Product(s)

Figure 4. Test circuit

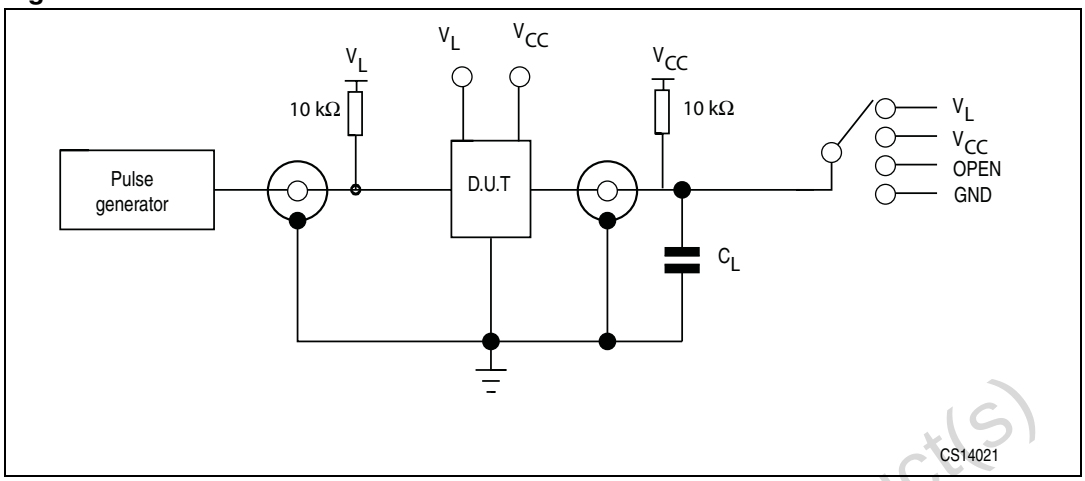


Table 13. Test circuit switches

Test	Switch		
	Driving I/O_{VL}	Driving I/O_{VCC}	Open drain driving
t_{PLH}, t_{PHL}	Open	Open	Open

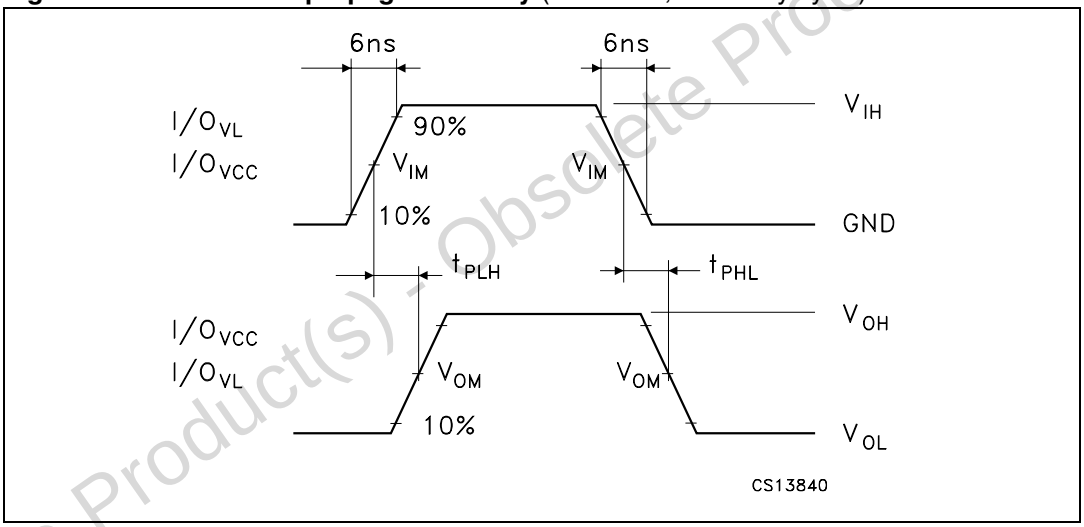
Obsolete Product(s) - Obsolete Product(s)

6 Waveforms

Table 14. Waveform symbol value

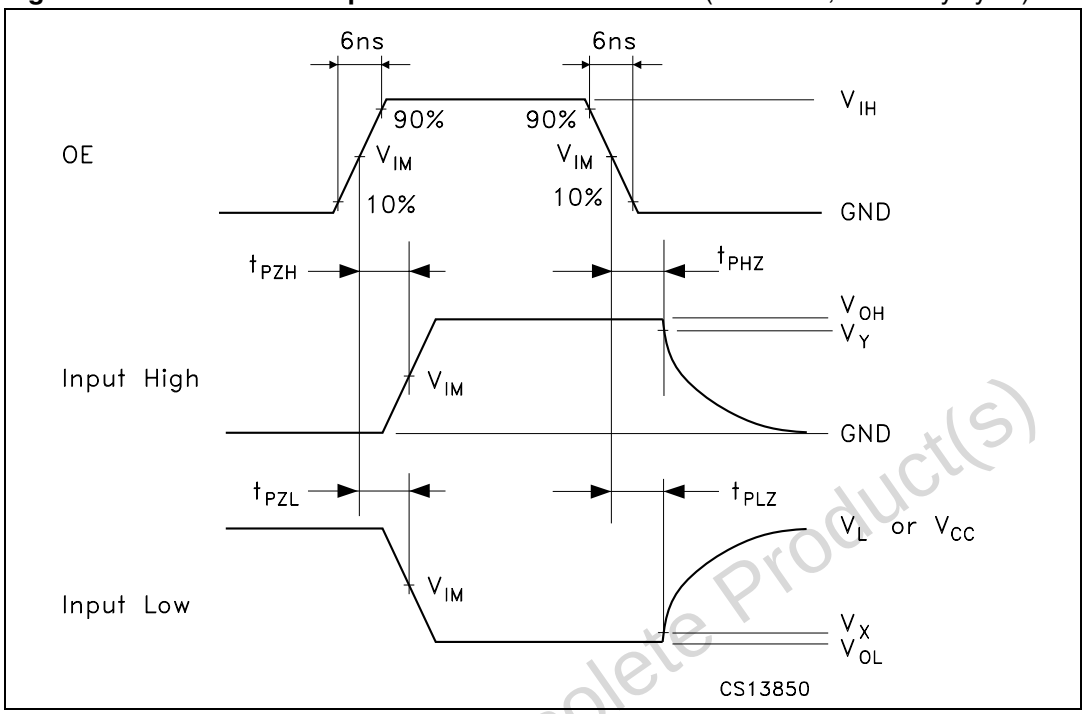
Symbol	Driving I/O_{VL}		Driving I/O_{VCC}	
	1.8 V ≤ V_L ≤ V_{CC} ≤ 2.5 V	**3.3 V ≤ V_L ≤ V_{CC} ≤ 5.0 V**	**1.8 V ≤ V_L ≤ V_{CC} ≤ 2.5 V**	**3.3V ≤ V_L ≤ V_{CC} ≤ 5.0 V**
V_{IH}	V_L	V_L	V_{CC}	V_{CC}
V_{IM}	50% V_L	50% V_L	50% V_{CC}	50% V_{CC}
V_{OM}	50% V_{CC}	50% V_{CC}	50% V_L	50% V_L
V_X	V_{OL} +0.15V	V_{OL} +0.3V	V_{OL} +0.15V	V_{OL} +0.3V
V_Y	V_{OH} -0.15V	V_{OH} -0.3V	V_{OH} -0.15V	V_{OH} -0.3V

Figure 5. Waveform - propagation delay (f = 1 MHz; 50% duty cycle)



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Figure 6. Waveform - output enable and disable time (f = 1 MHz; 50% duty cycle)

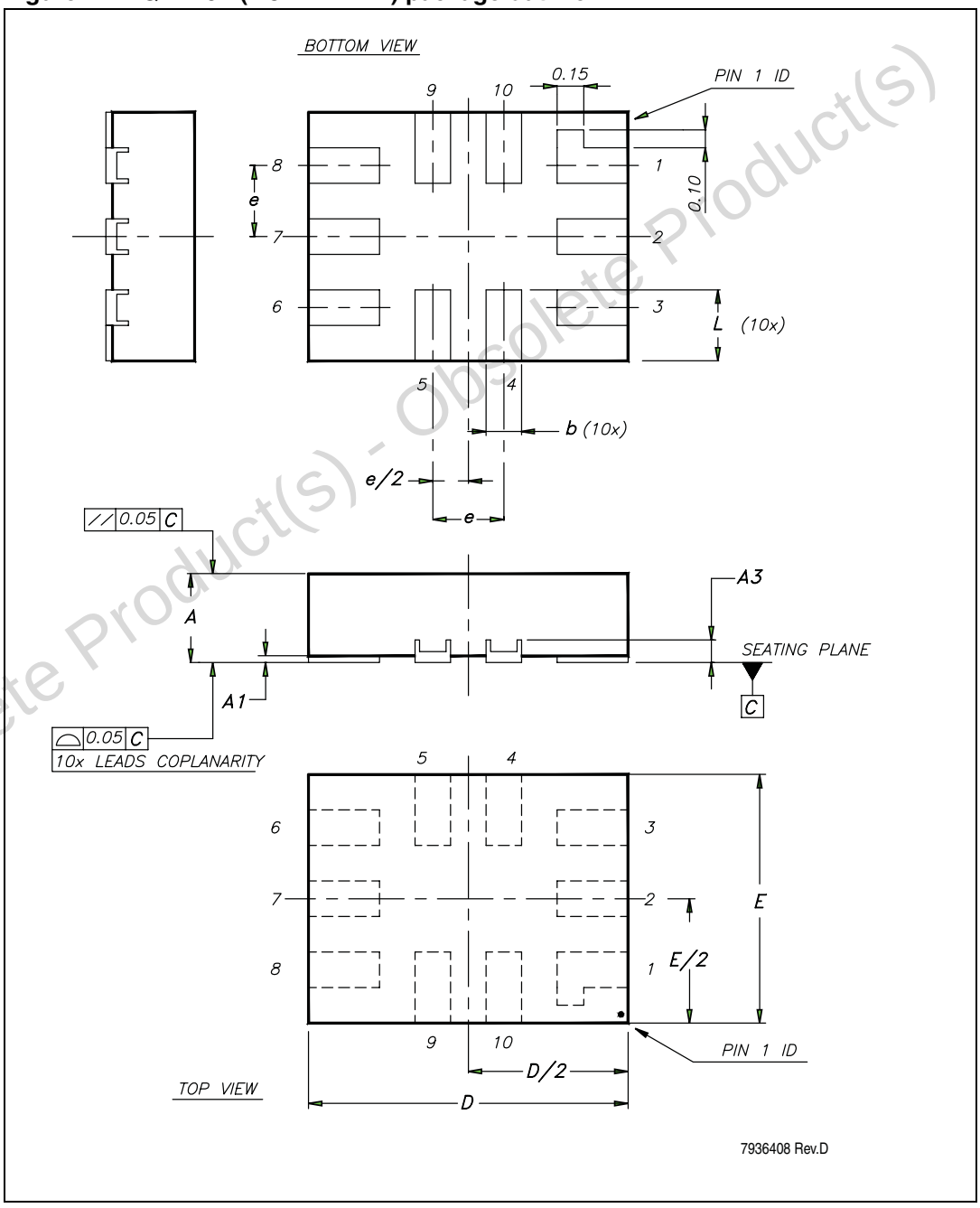


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7 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

Figure 7. QFN10L (1.8 x 1.4 mm) package outline

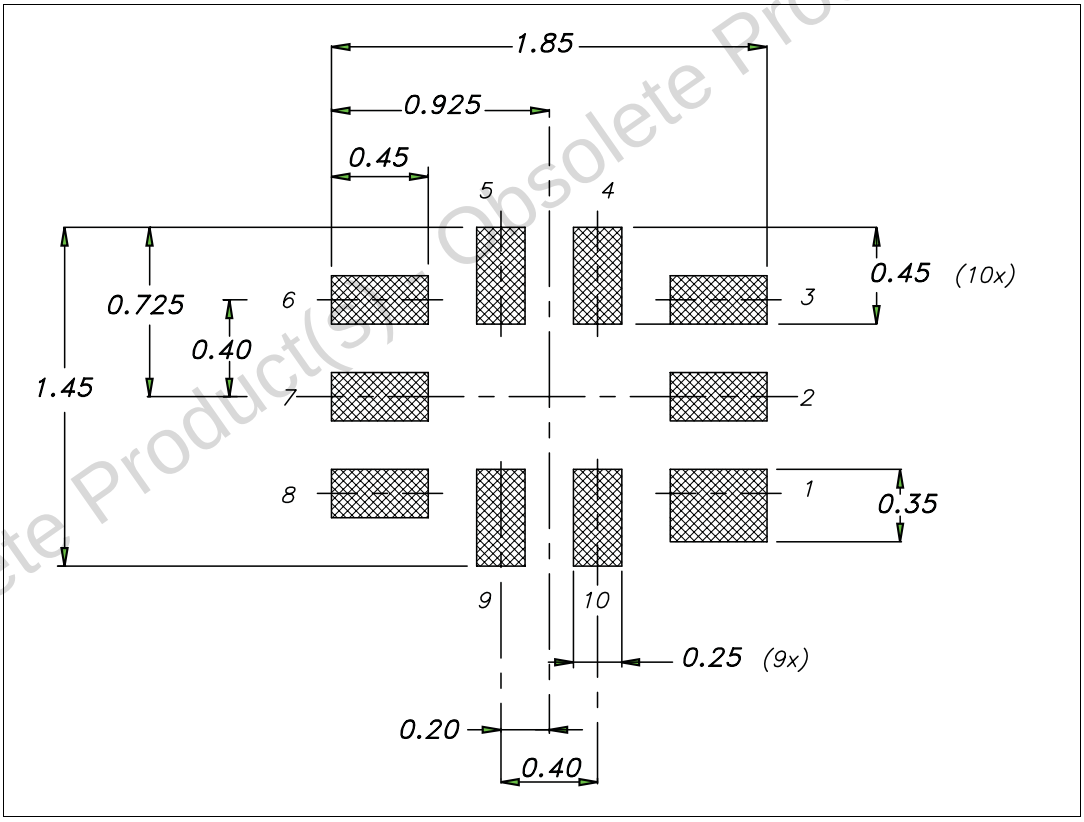


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Table 15. QFN10L (1.8 x 1.4 mm) mechanical data

Symbol	Millimeters		
	Typ	Min	Max
A	0.50	0.45	0.55
A1	0.02	0	0.05
A3	0.127		
b	0.20	0.15	0.25
D	1.80	1.75	1.85
E	1.40	1.35	1.45
e	0.40		
L	0.40	0.35	0.45

Figure 8. QFN10L (1.8 x 1.4 mm) footprint recommendation



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Figure 9. QFN10L (1.8 x 1.4 mm) carrier tape

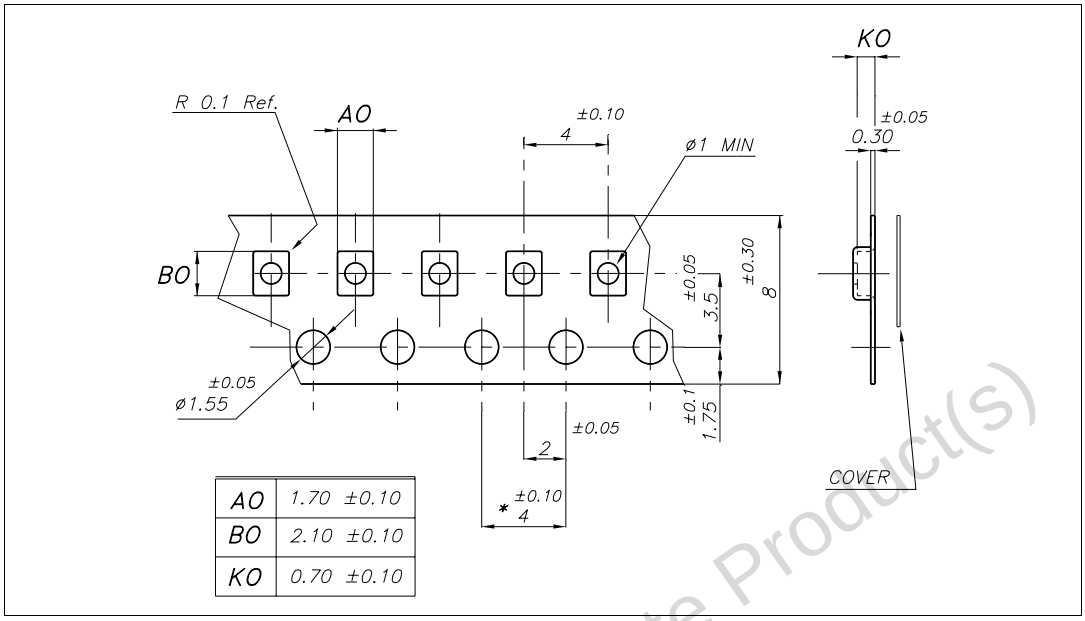
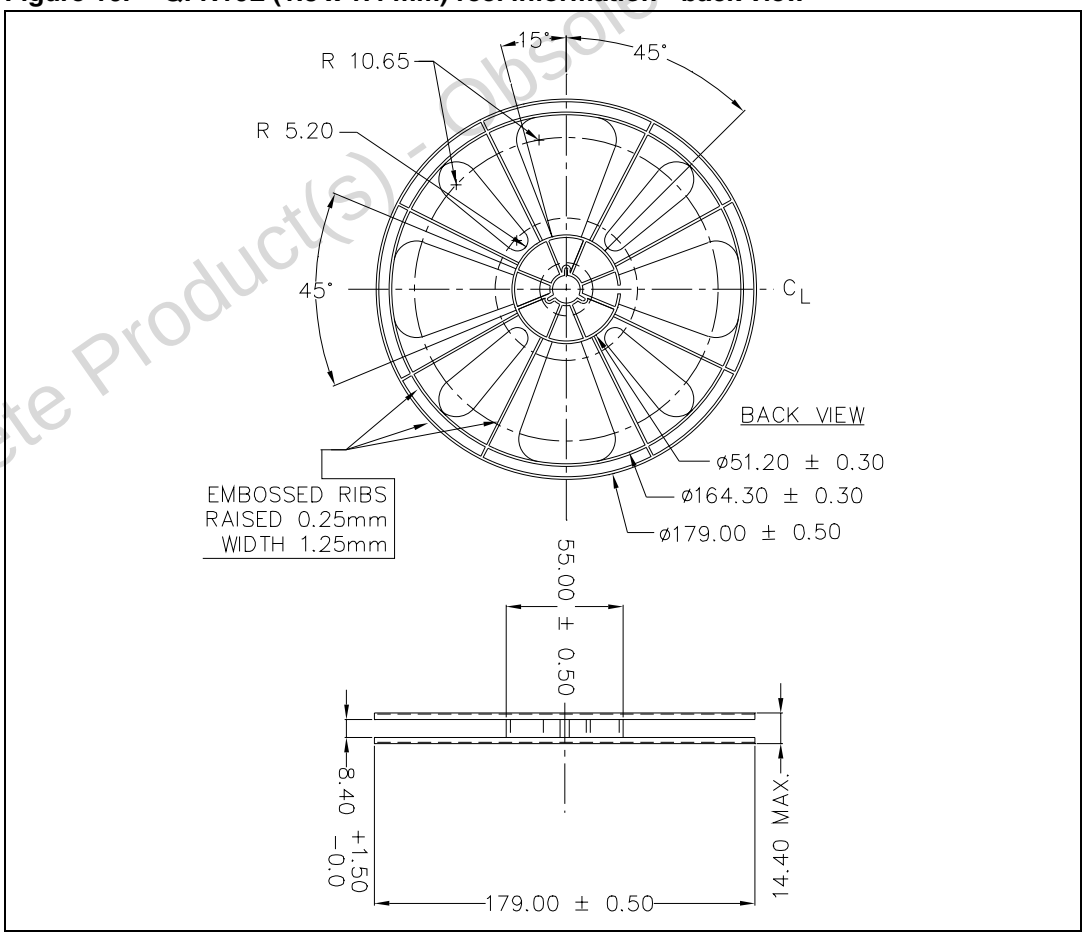
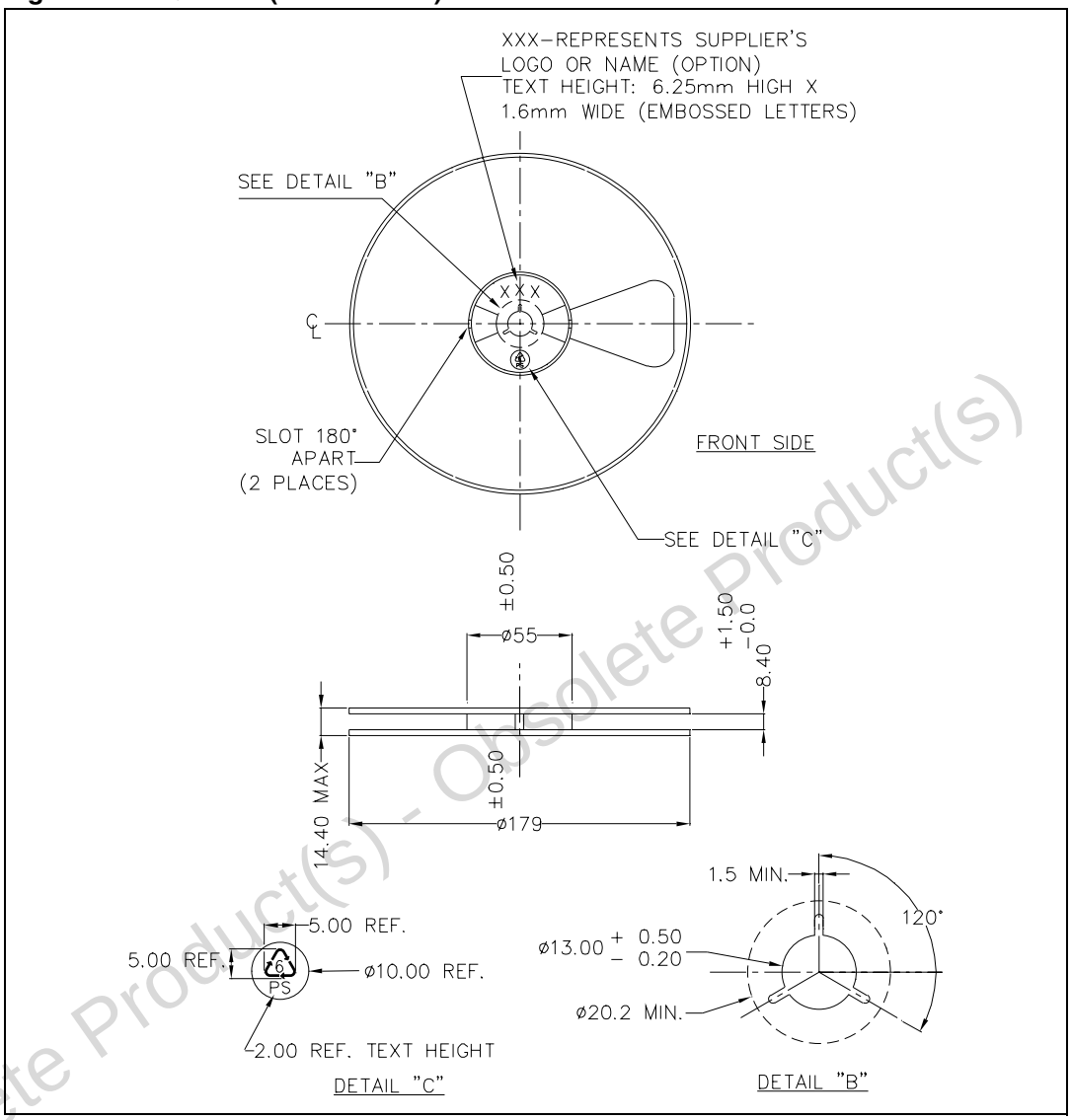


Figure 10. QFN10L (1.8 x 1.4 mm) reel information - back view



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Figure 11. QFN10L (1.8 x 1.4 mm) reel information - front side



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8 Revision history

Table 16. Document revision history

Date	Revision	Changes
15-May-2007	1	Initial release
01-Oct-2007	2	Modified title, added pin description and complete electrical characteristics
31-Oct-2007	3	Updated *Figure 4: Test circuit on page 13*, *Figure 7: QFN10L (1.8 x 1.4 mm) package outline on page 16* and *Figure 8: QFN10L (1.8 x 1.4 mm) footprint recommendation on page 17* , minor text changes.
07-May-2008	4	Updated data rate values and added paragraph on load driving capability (*Section 3.2*).

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